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To the Director of the U.S. Patent and Trademark Office: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies): Yoshimi Kikuchi,
Daisuke Higuchi, and Yeoh Kian Hockadditional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

6-27-01

2. Name and address of receiving party(ies):

Name: Sankyo Seiki Mfg. Co. Ltd.

Address: 5329 Shimosuwa-machi, Suwa-gun,
Nagano-ken, Japan

Address: _____

City: _____ State: _____ Zip: _____

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: May 19, 2001, May 24, 2001 and
May 30, 2001Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application No. 09/764,964

Filed: January 17, 2001

If this document is being filed together with a new application, the execution date of the application is: _____

B. Patent No(s).

Additional numbers attached? ☐ Yes ☒ No5. Name and address of party to whom correspondence
concerning document should be mailed:Name: Eugene LeDonne, Esq.
REED SMITH LLP
375 Park Avenue
New York, NY 101526. Total number of applications and
patents involved: 1

7. Total fee (37 CFR 3.41): \$ 40.00
☒ Enclosed
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☒ Charge any deficiency to deposit account

8. Deposit account number:

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9. Statement and signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true
and correct copy of the original document.

Eugene LeDonne

Name of Person Signing

Signature

June 22, 2001

Date

Total number of pages including cover sheet, attachments, and document: 3

Mail documents to be recorded with required cover sheet information to:
Director of the U.S. Patent and Trademark Office, Box Assignments
Washington, D.C. 20231

PATENT
REEL: 011930 FRAME: 0326

ASSIGNMENT

WHEREAS, the undersigned (hereinafter referred to as ASSIGNOR) have invented a certain invention entitled AUTOMATIC BALANCING APPARATUS which was filed at the United States Patent and Trademark Office on January 17, 2001, and granted Application No. 09/764,964.

WHEREAS, Sankyo Seiki Mfg. Co. Ltd, a corporation organized and existing under the laws of Japan and having a place of business at 5329, Shimosuwa-machi, Suwa-gun, Nagano, Japan (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire interest in, to and under said invention and in, to and under Letters Patent or similar legal protection to be obtained therefor in the United States and in any and all foreign countries.

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the full and exclusive right, title and interest to said invention in the United States and its territorial possessions and in all foreign countries and to all Letters Patent or similar legal protection in the United States and its territorial possessions and in any and all foreign countries to be obtained for said invention by any application or any continuation, divisional, renewal, substitute or reissue thereof or any legal equivalent thereof in a foreign country for the full term or terms for which the same may be granted.

ASSIGNOR HEREBY COVENANTS that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale; and

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof in any foreign country which may be necessary or desirable to carry out the purposes thereof.

Yoshimi Kikuchi
Yoshimi Kikuchi

Date: May 19, 2001

Daisuke Higuchi
Daisuke Higuchi

Date: May 24, 2001

Yeoh Kian Hock
Yeoh Kian Hock

Date: May 30, 2001

E. Knoch
Signature of Witness

Date: May 22, 2001

E. Knoch
Signature of Witness

Date: June 12, 2001

E. Knoch
Signature of Witness

Date: June 12, 2001